

# 2SK1669 Silicon N Channel MOS FET

REJ03G0966-0200 (Previous: ADE-208-1310) Rev.2.00 Sep 07, 2005

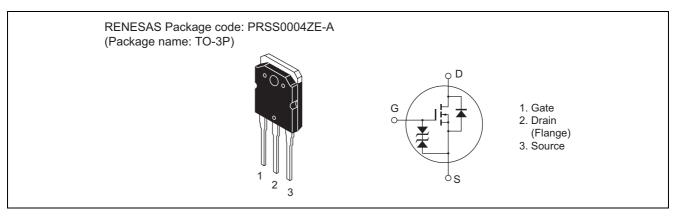
### Application

High speed power switching

### Features

- Low on-resistance
- High speed switching
- Low drive current
- Built-in fast recovery diode ( $t_{rr} = 90 \text{ ns}$ )
- Suitable for motor control, switching regulator and DC-DC converter

### Outline





# **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
ltem	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	250	V
Gate to source voltage	V <sub>GSS</sub>	±30	V
Drain current	ID	30	А
Drain peak current	I <sub>D(pulse)</sub> *1	120	А
Body to drain diode reverse drain current	I <sub>DR</sub>	30	А
Channel dissipation	Pch <sup>*2</sup>	125	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu s,\,duty\,cycle \leq$  1%

2. Value at  $T_C = 25^{\circ}C$ 

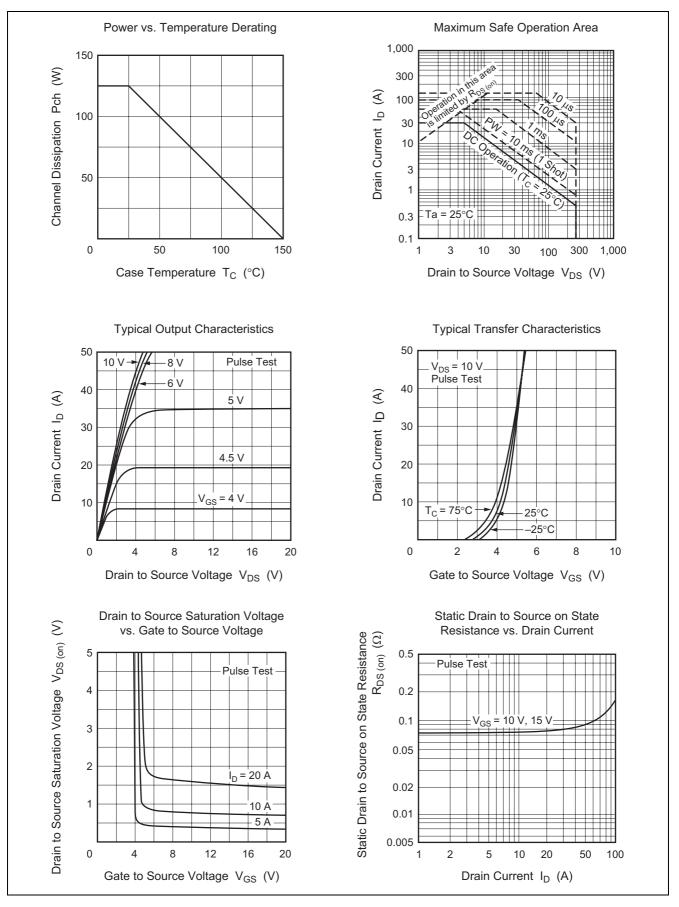
## **Electrical Characteristics**

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	250	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±30	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	—	±10	μA	$V_{GS} = \pm 25 V, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	—	250	μA	$V_{DS} = 200 V, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	2.0	—	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R <sub>DS(on)</sub>	_	0.075	0.095	Ω	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$
resistance						
Forward transfer admittance	y <sub>fs</sub>	12	20	_	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	Ciss		3100		pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss		1330		pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	190		pF	
Turn-on delay time	t <sub>d(on)</sub>	_	45		ns	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	tr	_	170	_	ns	$R_L = 2 \Omega$
Turn-off delay time	t <sub>d(off)</sub>	_	270	_	ns	
Fall time	t <sub>f</sub>		150	_	ns	
Body to drain diode forward voltage	$V_{DF}$		1.0	_	V	$I_F = 30 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	—	90	—	ns	I <sub>F</sub> = 30 A, V <sub>GS</sub> = 0, di <sub>F</sub> /dt = 100 A/μs

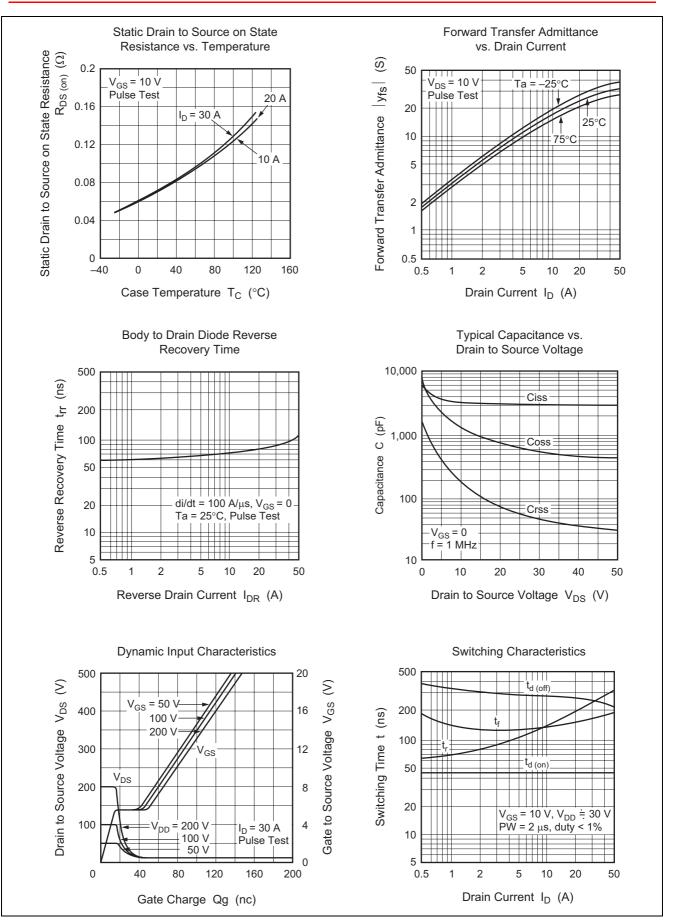
Note: 3. Pulse test



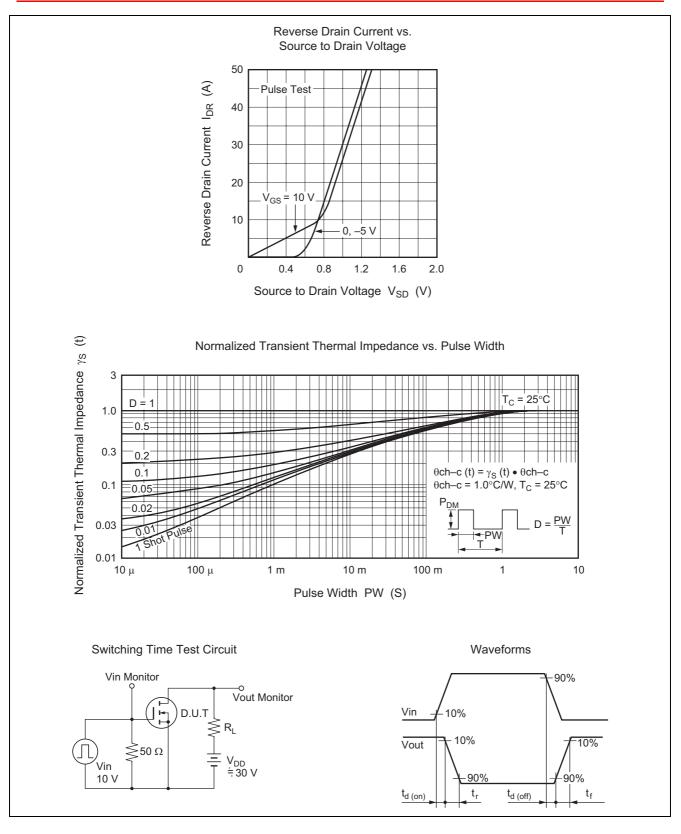
### **Main Characteristics**





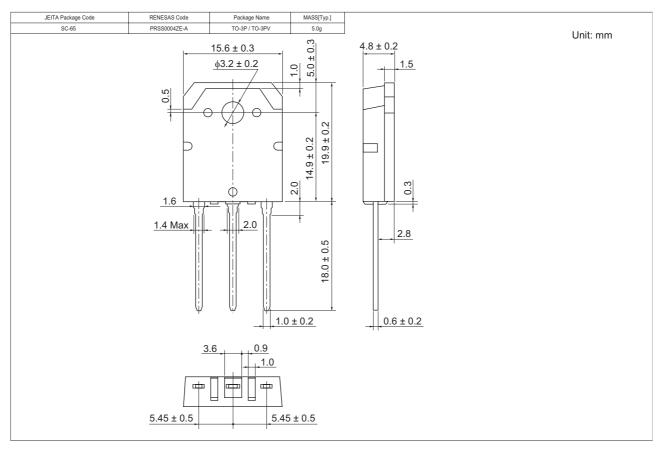








# Package Dimensions



### **Ordering Information**

Part Name	Quantity	Shipping Container
2SK1669-E	360 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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